Fabrication techniques and morphological analysis of perovskite absorber layer for high-efficiency perovskite solar cell: A review

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ABSTRACT

Organolead trihalide perovskite absorber layers are potential contenders in solar energy harvesting technologies because of their competitive lower fabrication cost, high power conversion efficiency, and ease of processing. The structural, interfacial and morphological properties are the key aspects to determine the stability and photon-to-current conversion efficiency of Perovskite solar cells (PSCs). Most contemporary research has emphasised on enhancing the power conversion efficiency (PCE) of perovskites by changing the fabrication process, solvent engineering, or precursor solution. With changes in these variables, the structure and morphology of perovskites also change, which affects the photon-to-current conversion efficiency and the stability of the PSCs. However, no stockpiled records have aided in conducting corresponding research outcomes on this perspective. In this review, we summarise the effect of fabrication method on the structure and morphology, as well as the PCE and stability of PSCs. This review will help readers decipher the scientific and technological challenges concerning hybrid inorganic–organic PSCs.

1. Introduction

The conversion of solar radiation to electricity by a photovoltaic cell was first demonstrated in 1954. Due to the formation of a p–n barrier in silicon, photons were observed to generate electron–hole pairs which could be successfully transported to an external circuit [1]. Over the past five decades, silicon solar cells (SCs) have shown significant progress with high energy output and affordable production cost [2,3]. At present, the current global photovoltaic (PV) market is fully dominated by the crystalline silicon technology, in which 55% and 36% are polycrystalline and monocrystalline silicon modules, respectively. The remaining share of the PV market is open to the development of organic PVs (OPVs), perovskite solar cells (PSCs), dye-sensitised solar cells (DSSCs), quantum dot solar cells (QDSCs) and polycrystalline thin-film solar cells [4,5]. In comparison with other 1st generation SCs, Si-SCs have led to reduce cost with few limitations. Due to dependency on vacuum and temperature conditions during manufacturing, the processing costs of these SCs are still high. Although the PV market is dominated by silicon-based solar cells, the price range of these solar cells remains below an affordable level for individual users due to their complex manufacturing process, high energy consumption, and high throughput cost [6–8]. The 3rd-generation SCs such as PSCs, OPVs, QDSCs, and DSSCs have offered a great versatility in terms of lighter weight, flexibility, choice of various synthesised material, simple device fabrication techniques, and most importantly, commercial-scale production with low cost [9–13]. Although the overall performance of 3rd-generation SCs has exhibited rapid evolution at the research scale, they lag behind other types of solar cells. Critical bottlenecks, such as limited efficiency, toxicity, and cost, and challenges with stability, reproducibility, and scalability hinder their ability to compete with existing solar technologies in power grid applications and the current electronics market. Considering the above-mentioned pros and cons, hybrid inorganic–organic PSCs are considered as one of the rising stars in the PV industry due to their high efficiency, low-temperature processing, and...
easy fabrication techniques.

Hybrid inorganic–organic perovskites indicate high absorption coefficients, high charge-carrier mobility, low exciton binding energy, long exciton diffusion length, and an easily tuneable band gap [14–19]. The staggering properties of the perovskite absorber have led to an increase in PCE from 3.8% to 22.1% within a period of only eight years [20,21]. However, PSCs are challenged with long-term stability and reproducibility problems, mainly due to the unstable behaviour of perovskite compounds in an ambient environment, and the synergistic factors of the functional components in PSCs [22]. Salhi et al. reviewed in depth the latest developments and shortcoming in the stability of PSCs. They presented moisture, elevated temperature, UV light, and exposure to the environmental condition as the leading causes of degradation in the PSCs [23]. Ansari et al. extensively reviewed the challenges and opportunities of perovskite solar cells. They focussed on the role of structure and composition of perovskite materials, and the deposition methods used for the perovskite layer [24]. Understanding the role of fabrication procedures in perovskite absorbers is important to further enhancing PV performance and reducing the overall production costs for role-to-role production. Low cost, easy reproduction, and facile deposition techniques are preferred for the fabrication of perovskite films. Various methods have already been subject to intense investigation, and have been verified for the fabrication of high-quality perovskite layers for high-efficiency PSCs. Given that the film quality of perovskite plays a pivotal role in the overall performance of solar cells, obtaining high-quality perovskite films with high phase purity, fewer structural defects, suitable morphology, and high crystallinity are necessary.

In this review, we elaborate on the structure of perovskite materials and their development chronologically to the present day. The main part of this work discusses existing fabrication methods of perovskite film for PSCs applications. By considering the aforementioned technical and theoretical aspects, we discuss all existing fabrication methods of perovskite film with structural and morphological analysis for PSCs applications. Notably, the phase transition, microstructure, defect states, band gap, and optical properties of perovskite films are strongly affected by the post-operating temperatures and deposition methods. Moreover, the band gap, optical constant, and optical absorption may also be affected by processing techniques. Therefore, in this review, we focus on the correlation of the structural and morphological properties of perovskite films with their corresponding deposition techniques at the end of each section.

### 1.1. Structure and properties of perovskite compounds

Universally, the general chemical formula for perovskite material is AMX$_3$. It consists of two different sizes of cations (‘A’ and ‘M’) and one anion (‘X’), in which the ideal cubic symmetry of the ‘M’ cation is located in six-fold coordination while it is encircled by an octahedron of anion (‘X’), in which the ideal cubic symmetry of the ‘M’ cation is located in six-fold coordination while it is encircled by an octahedron of anion, while the ‘A’ cation is in a twelve-fold cuboid octahedral coordination, as shown in Fig. 1.

The most attractive features of perovskite structures are organic molecule cations that are based on amine (CH$_3$NH$_3$)$^+$) at ‘A’ sites, metal cations (Ge$^{2+}$, Sn$^{2+}$ and Pb$^{2+}$) at ‘M’ sites, and halide anions (Cl$^-$, Br$^-$ and I$^-$) at ‘X’ sites. The extraordinary properties of this unique structure has led to significant interest among scientists worldwide [26]. In 1978, Weber synthesised the first organic-inorganic halide perovskite CH$_3$NH$_3$PbI$_3$ [27], which exhibited different colours when the stoichiometric parameter was varied. The ion ‘A’ balances the charge of the framework without distorting the crystal lattice and a final effect on the band gap [28–30]. A series of materials with different band gaps can be obtained by controlling the size of the ‘A’ ion. Metal–halide bond angle also indicates a significant effect on the band gap. The band gap of the metal halide increases with the decrease in bond angle. The band gap of various metal halides is shown in Table 1. Studies also show that the stability of the perovskite group follows the trend AGeI$_3$ < ASnI$_3$ < APbI$_3$ [31].

Other mixed-lead halide perovskite compounds, such as CH$_3$NH$_3$Pb$_{1-x}$Cl$_x$, have direct band gaps in the range of 1.61–1.96 eV [33]. CH$_3$NH$_3$PbI$_3$–Br, shows direct band gaps of 1.58–2.28 eV [30], which depend on the value of x. Therefore, these materials are excellent light absorbers that can effectively cover a wide range of solar emission spectra from ultraviolet to infrared wavelength regions. CH$_3$NH$_3$PbI$_3$ contains weak bond exciton binding energy ranging from 37 meV to 50 meV and provides a pathway for easy movement of free carriers [34–36]. It shows exceptional charge carrier transportation properties that make it a popular choice for optoelectronic device fabrication. As a single crystal, CH$_3$NH$_3$PbI$_3$ has large diffusion length that exceeds 175 µm, whereas in the form of thin film, CH$_3$NH$_3$PbI$_3$–xCl$_x$ has a diffusion length of up to 1 µm, as presented in Table 2. Carrier mobility and recombination were measured for single crystals using Hall effect measurement and impedance spectroscopy, respectively, at 1 sun illumination. However, diffusion lengths of single crystals and thin films were measured by combining the mobility and lifetime. The Hall effect measurement was conducted with a sample size of 1.5 mm × 1.5 mm × 1 mm in dark conditions. All four electrodes were made of Ga. A source meter (Keithley 4200) was used to apply DC current, and a different source meter (Keithley 4200) was used to record the Hall voltage. The carrier recombination of thin film was measured by a laser flash spectrometer (LP920). The measurement was based on a standard transient absorption setup. During this observation, a nanosecond laser pulse is used to excite the sample. The time evolution of the differential absorption changes induced by the pump which is monitored by a continuous wave light source probe.

Fig. 2 provides the electronic band structure of AMX$_3$ perovskite (A = CH$_3$NH$_3$, CH$_3$NH$_2$I$_2$, Cs; M = Pb, Sn; X = I, Br, Cl) with several crystal structures. In Fig. 2(a)–(d), the band gaps increase with increasing electronegativity of M–site and X-sites, and decreasing symmetry of the crystal structures (orthorhombic > tetragonal > cubic). However, there is no existing mechanism to explain the change in band gap with the variation in the A cation [37].

### 1.2. Chronological development of PSCs

The chronological development of PSCs is shown in Table 3. In 2009, Miyasaka first introduced PSCs with mesoporous TiO$_2$ as the template for CH$_3$NH$_3$PbI$_3$ and CH$_3$NH$_3$PbBr$_3$ as a photoactive layer, which resulted in a PCE of 3.81% [21]. Park et al. optimised a method

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**Table 1**

<table>
<thead>
<tr>
<th>Material</th>
<th>LUMO/eV</th>
<th>HOMO/eV</th>
<th>Eg/eV</th>
</tr>
</thead>
<tbody>
<tr>
<td>CH$_3$NH$_3$PbI$_3$</td>
<td>3.88</td>
<td>5.39</td>
<td>1.51</td>
</tr>
<tr>
<td>CH$_3$NH$<em>3$Sn$</em>{1-x}$Pb$_x$I$_3$</td>
<td>3.81</td>
<td>5.12</td>
<td>1.31</td>
</tr>
<tr>
<td>CH$_3$NH$<em>3$Sn$</em>{1-x}$Pb$_x$I$_3$</td>
<td>3.67</td>
<td>4.95</td>
<td>1.28</td>
</tr>
<tr>
<td>CH$<em>3$NH$<em>3$Sn$</em>{1-x}$I$</em>{2x}$</td>
<td>3.69</td>
<td>4.92</td>
<td>1.23</td>
</tr>
<tr>
<td>CH$<em>3$NH$<em>3$Pb$</em>{1-x}$I$</em>{2x}$</td>
<td>3.57</td>
<td>4.75</td>
<td>1.18</td>
</tr>
<tr>
<td>CH$_3$NH$_3$I$_3$</td>
<td>3.63</td>
<td>4.73</td>
<td>1.10</td>
</tr>
</tbody>
</table>

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**Fig. 1.** Molecular structure of perovskite compound (Reprint permission from Ref. [25]).
of depositing electrolytes in perovskite formulation with an increased PCE of up to 6.5% [41]. Subsequently, in 2012, two groups led by Grätzel and Park, and Snaith et al. reported major breakthroughs in PSC technology, thereby providing insight on the potential use of PSCs. Park and Grätzel replaced the liquid electrolyte with Spiro-OMeTAD as an HTM and fabricated an all-solid-state PSCs, which achieved 9.7% efficiency [42]. Snaith and co-worker reported the mesoporous (mp) framework of alumina (Al₂O₃) instead of the mp-TiO₂ on TiO₂ compact layer (FTO/Compact TiO₂/Mesoporous Al₂O₃ or mesoporous TiO₂/CH₃NH₃PbI₂Cl/Spiro-OMeTAD/Ag) which further increased the PCE to 10.9% by using a mixed halide CH₃NH₃PbI₃−xClₓ absorber [43]. Incorporation of a mesoporous Al₂O₃ insulator along with compact TiO₂ obstructed any formation of near-band-gap density of states compared to mp-TiO₂-based PSCs. This phenomenon contributed to the transportation of electrons within the perovskite, and increased the open-circuit voltage (Vₒc) up to 1.12 V. However, Al₂O₃ possesses an unfavourable electronic energy level due to the band alignment mismatch for electron transfer to Electron transport layer (ETL) from perovskite layer. The conduction band (CB) edge of alumina (~ − 2.1 eV) [44] is greater than the CB-edge of Perovskite (− 3.9 eV), confirming that the electron tends to remain within perovskite rather than being transported to n-type TiO₂ [45]. At the end of 2012, Grätzel et al. proposed a hole conductor-free mesoscopic-PSC, which recommended that the perovskite compound itself could facilitate as hole conductor in PSCs [46]. In 2013, numerous fabrication techniques for perovskite absorber materials were reported in mesoporous and planar structures.

<table>
<thead>
<tr>
<th>Perovskite Compound</th>
<th>Carrier Mobility (cm² V⁻¹ s⁻¹)</th>
<th>Carrier Recombination (μs)</th>
<th>Diffusion Length, Lₒ (μm)</th>
<th>Refs.</th>
</tr>
</thead>
<tbody>
<tr>
<td>CH₃NH₃PbI₃ SC</td>
<td>24.8 ± 4.1</td>
<td>95</td>
<td>− 175</td>
<td>Dong et al. [38]</td>
</tr>
<tr>
<td>CH₃NH₃PbI₃ Br SC</td>
<td>2.5</td>
<td>0.357</td>
<td>− 0.3–1.7</td>
<td>Shi et al. [39]</td>
</tr>
<tr>
<td>CH₃NH₃PbI₃ TF</td>
<td>0.0096</td>
<td>0.129 ± 41</td>
<td>1.069 ± 0.204</td>
<td>Stranks et al. [40]</td>
</tr>
<tr>
<td>CH₃NH₃PbI₃ Clₓ TF</td>
<td>0.2727</td>
<td></td>
<td></td>
<td>Stranks et al. [40]</td>
</tr>
</tbody>
</table>

SC Single Crystal, TF Thin film.

![Fig. 2. Calculated band structure for (a) pseudo-cubic structure of CH₃NH₃PbX₃ (X = I, Br, Cl) (b) tetragonal structure of CH₃NH₃MI₃ (M = Sn, Pb), (c) orthorhombic structure CsMI₃ (M = Sn, Pb) (d) orthorhombic structure of ASnI₃ (A = Cs, CH₂NHCH₂) (Reprint permission from Ref. [37]).](image-url)
Table 3
Chronicological development of perovskite solar cells.

<table>
<thead>
<tr>
<th>Year</th>
<th>Device Structure</th>
<th>Structure</th>
<th>Efficiency (%)</th>
<th>Refs.</th>
</tr>
</thead>
<tbody>
<tr>
<td>2009</td>
<td>TiO2/CH3NH2PbI2/Liquid electrolyte</td>
<td>–</td>
<td>3.81%</td>
<td>Kojima et al. [21]</td>
</tr>
<tr>
<td>2011</td>
<td>cl-TiO2/CH3NH2PbI2 QD /Liquid electrolyte</td>
<td>–</td>
<td>6.5%</td>
<td>Im et al. [41]</td>
</tr>
<tr>
<td>2012</td>
<td>cl-TiO2/mesoporous TiO2/CH(NH2)PbI2/Spiro-MeOTAD</td>
<td>mp</td>
<td>9.7%</td>
<td>Kim et al. [57]</td>
</tr>
<tr>
<td></td>
<td>cl-TiO2/mesoporous Al2O3/CH3NH3PbI2/Cl3/Spiro-OMeTAD</td>
<td>mp</td>
<td>10.9%</td>
<td>Lee et al. [43]</td>
</tr>
<tr>
<td></td>
<td>cl-TiO2/CH3NH2PbI3 Cl3/Spiro-OMeTAD</td>
<td>n-g</td>
<td>15.4%</td>
<td>Liu et al. [17]</td>
</tr>
<tr>
<td>2013</td>
<td>TiO2/CH3NH2PbI3 Cl3/Spiro-OMeTAD</td>
<td>n-p</td>
<td>15.0%</td>
<td>Burschka et al. [19]</td>
</tr>
<tr>
<td>2014</td>
<td>NiMgLiO/MAPbI3/Ti(Nb)Ox</td>
<td>p-i-n</td>
<td>15.6%</td>
<td>Chen et al. [58]</td>
</tr>
<tr>
<td></td>
<td>Yttrium-doped TiO2/Pervoskite/Spiro-OMeTAD</td>
<td>n-i-p</td>
<td>19.3%</td>
<td>Zhou et al. [49]</td>
</tr>
<tr>
<td>2015</td>
<td>ITO/PDOT/PSS/CH3NH3PbI3(MAPbI3)/PCBM</td>
<td>bl/TiO2/ mp-TiO2/ (FAPbI3)1-x(MAPbBr3)x/PCBM</td>
<td>20.1%</td>
<td>Yang et al. [50]</td>
</tr>
<tr>
<td></td>
<td>NiMgLiO/FA0.85MA0.15Pb(I0.85Br0.15)3/PCBM/ Ti(Nb)Ox</td>
<td>p-i-n</td>
<td>18.2%</td>
<td>Wu et al. [60]</td>
</tr>
<tr>
<td></td>
<td>Cl-TiO2/mp-TiO2/FAx,AMxCl (MAPbI3)1-x(MAPbBr3)x/Spiro-OMeTAD</td>
<td>mp</td>
<td>19.6%</td>
<td>Li et al. [61]</td>
</tr>
<tr>
<td>2017</td>
<td>FTO/thin-barrier TiO2/mp-TiO2/pervoskite composite layer/pervoskite upper layer/PTAA/Au</td>
<td>mp</td>
<td>22.1%</td>
<td>Yang et al. [20]</td>
</tr>
</tbody>
</table>

2. Deposition methods of perovskite films: structural and morphological analysis

Fabrication methods are broadly classified as (A) wet chemistry processing, and (B) vapour assisted processing. Wet processing methods include the one-step deposition (OSD) method, and sequential deposition method (SDM), and vapour-assisted processes are comprised of the vapour-assisted solution process (VASP), chemical vapour deposition (CVD), thermal vapour deposition (TVD) method, and microwave irradiation process (MIP). Here, we focus on the correlation of the structural and morphological properties of perovskite films with their corresponding deposition techniques.

2.1. Wet chemistry processing

2.1.1. OSD method

The first PSCs were developed by Kojima et al. in 2009 [21] where they followed Kitazawa’s method of fabricating a perovskite absorber layer, and investigated the optical properties of methylammonium lead iodide to produce mixed halide or iodide only [62]. In this method, the stoichiometric composition of organic halides (CH3NH3X) and lead halides (PbX2) were dissolved in DMSO inside a nitrogen glove box to prepare a methylammonium lead iodide (CH3NH3PbX3) solution, shown as follows.

\[
\text{PbX} + \text{CH}_3\text{NH}_3\text{X} \rightarrow \text{CH}_3\text{NH}_3\text{PbX}_3
\]

The CH3NH3PbX3 film was deposited by spin coating of the CH3NH3PbX3 precursor on top of the TiO2 layer. At first, the precursor was spin-coated at a low spinning rate, and after a few seconds, the spinning rate gradually increased to produce a dense layer of CH3NH3PbX3. Once the coating process was finished, the perovskite films were annealed [63]. A schematic of the OSD technique for the perovskite absorber layer is shown in Fig. 3.

Single-halide (CH3NH3PbI3) and mixed-halide (CH3NH3PbCl1–xIx) perovskite compound have been extensively applied to harvest light in PSCs [64]. Mixed halide shows superior PV performance, such as high charge carrier mobility, large exciton diffusion length, and small exciton binding energy [40] compared with other cell structures. The OSD method gained popularity for its one-step simple fabrication, which leads to slow crystallisation. The resultant CH3NH3PbX3 films shows high-density defects that result in limited performance for PSCs [25]. This deposition technique indicates that the quality of perovskite film mainly depends on the deposition conditions, such as annealing temperature, atmosphere environment, substrate materials, and film thickness [65]. To obtain a desirable film quality, uniformity of film thickness and morphology control are crucial parameters in the OSD method. Another challenge of the OSD method is reducing the pinholes in the perovskite film. To overcome all aforementioned issues in OSD, the anti-solvent dripping (ASD) method is introduced to regulate the kinetics of crystal growth and film quality [31]. A simple representation
of anti-solvent treatment for the OSD technique is shown in Fig. 4.

In the ASD method, the precursor of perovskite solution is dissolved into a DMSO and GBL mixed solution. Then the perovskite was formed on the substrate by spin coating. A certain amount of anti-solvent is dripped during spin coating and the substrate is annealed at 100 °C, which results in a uniform and smooth perovskite film with large grains [66]. A significant increase of PCE is observed due to the enhancement of surface morphology of perovskite film.

A comparative analysis of the CH$_3$NH$_3$PbI$_3$ absorber in OSD and ASD is shown in Fig. 5. Fig. 5(a) and (b) show the surface morphology of mesoporous TiO$_2$ and the OSD of CH$_3$NH$_3$PbI$_3$ on the top surface of the mp-TiO$_2$ layer, respectively. In Fig. 5(b), island-like non-uniform CH$_3$NH$_3$PbI$_3$ crystals on top of the mp-TiO$_2$ layer can be observed, which may be attributed to the wettability and presence of two cations on the coating solution [67]. Upon successful ASD treatment, a dense layer of larger grain size (100–500 nm) CH$_3$NH$_3$PbI$_3$ crystals are observed as shown in Fig. 5(c). This significant formation of CH$_3$NH$_3$PbI$_3$ crystals by the ASD method has boosted perovskite research to an entirely new dimension.

Different anti-solvents, such as C$_6$H$_5$Cl, C$_6$H$_6$, C$_6$H$_5$(CH$_3$)$_2$, C$_6$H$_2$CH$_3$, CH$_2$OH, C$_6$H$_5$OH, C$_6$H$_5$O$_2$, (CH$_2$)$_2$CHOH, CHCl$_3$, (CH$_2$)$_2$CH$_2$O, CH$_3$CN and C$_6$H$_5$(CN) have been used for the preparation of high-quality Pb-based perovskite crystalline films [17,18,69,70]. Scanning electron microscopy (SEM) reveals outstandingly different surface morphologies of MAPbI$_3$ film formed by different anti-solvents, as shown in Fig. 6. The surface morphology of the MAPbI$_3$ film is significantly changed by the ASD method. Many voids and pinholes are observed during the deposition perovskite layer by OSD method. By contrast, the smooth and homogeneous surface morphology from the anti-solvent process unveils pinholes with large MAPbI$_3$ crystals which are densely packed. Average particle sizes are 158, 148, 87, 195, and 288 nm for MAPbI$_3$ films treated with toluene, chlorobenzene, chloroform, diethyl ether, and diisopropyl ether, respectively [71]. The large crystallite size of MAPbI$_3$ is obtained treating by diisopropyl ether compared to films prepared by other solvents, such as C$_6$H$_5$Cl, C$_6$H$_5$CH$_3$, CHCl$_3$, or (C$_2$H$_5$)$_2$O. A better quality and entire surface coverage of MAPbI$_3$ film substantially enhances PSCs performance and improves the continued reproducibility of PSCs.

Xiao et al. first fabricated compact perovskite films with full surface coverage by using a fast deposition–crystallisation method. They manage to get complete surface coverage perovskite layer. Chlorobenzene as an anti-solvent is dripped after the initial few seconds of spin coating of a perovskite precursor and obtained a PCE of 13.0% under 1.0 sun illumination conditions [70]. The purpose of using anti-solvent was to rapidly reduce the solubility of CH$_3$NH$_3$PbI$_3$ quickly in the DMF and DMSO mixed solvent, and promoting fast nucleation and formation of CH$_3$NH$_3$PbI$_3$ crystals in the film. The film morphology was highly uniform over the entire substrate for C$_6$H$_5$Cl, C$_6$H$_6$, C$_6$H$_5$(CH$_3$)$_2$ and C$_6$H$_5$CH$_3$ anti-solvents. However, the non-uniformity was observed in the central area of the perovskite films while using different anti-
solvents [72]. In 2016, Son et al. fabricated high-performance CH$_3$NH$_3$PbI$_3$ film by using diethyl ether as an anti-solvent, and improved PCE up to 20.1% for over 50 cells. They reduced the current-voltage hysteresis behaviour by using grain boundary healing process [69]. Jeon et al. fabricated highly uniform and thick perovskite absorber layer by toluene drop casting method using a mixture solvent of GBL and DMSO. In this process, they achieved certified PCE of 16.2% without hysteresis [31]. The addition of MAPbBr$_3$ into FAPbI$_3$ stabilised perovskite phase of FAPbI$_3$ with toluene as the anti-solvent agent, thereby improving the PCE of the PSC by more than 18% [18]. In 2017, Yang et al. showed that the concentration of defect states reduced the overall PSC performance. They showed that the concentration of deep-level defects could be reduced by ASD treatment. By adding excess tri-iodide ions into precursor solution achieved a certified PCE 22.1% and 19.7% for small cells and in 1 cm cells, respectively [20].

To enhance the morphology, stability, and excitonic and optoelectronic properties of hybrid inorganic–organic perovskite film, the addition of favourable additives have facilitated perovskite crystal growth. Various polymers, metal halide salts, organic halide salts, polymer, fullerene, nanoparticles, and inorganic acids are the additives most widely used to enhance the morphology of thin-film perovskites [73]. Polymers indicate a significant influence as additives to enhance uniform crystallisation, optimise the kinetics of crystal growth, and improve device performance. Polyelectrolyte glycol (PEG) [74,75], amine-polymer poly[9,9-bis(3’-(N,N-dimethylamino) propyl)-2,7-fluorene]-alt-2,7-(9,9-diocetylfluorene)] [76], polyvinylpyrrolidone [77], and polyacrylonitrile [78] are the most commonly used polymer additives for PSCs. Poor morphology control and surface coverage of the CH$_3$NH$_3$PbI$_3$-Cl$_x$ film on TiO$_2$ are common problems for PSCs. Su et al. first solved this problem by using polyethylene glycol (PEG) as an additive in a CH$_3$NH$_3$PbI$_3$ precursor during the fabrication process, and successfully enhanced PCE ~ 25% more by adding 1 wt% of PEG. The SEM micrograph in Fig. 7 shows the change in surface coverage and morphology of CH$_3$NH$_3$PbI$_3$ layer from changing the amount of PEG. In the case of pristine perovskite film, crystals grow and aggregate in the large domain with poor coverage (86.44%), whereas 1 wt% PEG added to perovskite film decreases the size of the domain and void, and increases the coverage area (98.13%). However, an interesting feature is that the size and amount of crystal and void continuously increase with the amount of PEG added [74].

Alkali metal halide salts, such as NaI, CuI, CuBr, AgI [79], NaCl, and KCl [80], are used as additives in the CH$_3$NH$_3$PbI$_3$ precursor during PSC fabrication which aids in enhancement of crystal growth of PbI$_2$ films by chelating with Pb$^{2+}$ ions. As a result nanostructured morphologies of PbI$_2$ film is observed. These films of PbI$_2$ promote homogeneous nucleation and large crystal sizes, which enhance the morphology and crystalline properties of CH$_3$NH$_3$PbI$_3$ films. The aforementioned metal halides influence recrystallization of small grains, passive grain boundaries and interfacial states, thereby permitting for efficient electron-hole pair generation and dissociation in CH$_3$NH$_3$PbI$_3$ films. Photoluminescence (PL) intensity measurements indicate that CH$_3$NH$_3$PbI$_3$ films prepared with salt additives feature a small number of recombination. The PCE is enhanced by 33% upon incorporation a small amount of alkyl halide. Moreover, the device stability is increased with only 16.5% degradation over 50 days compared to device prepared without the additive.

Han et al. explored a route to control and improve perovskite crystallisation by using methyl ammonium acetate (MAAc) and thiosemicarbazide (TSC) with molar ratios of 10–15% and 3–5%, respectively. Introducing MAAc in the precursor solution aids in generating a highly uniform MAPbI$_3$ film with full coverage morphology using the OSD method; however, a small amount of TSC efficiently improves the perovskite crystal size, as shown in Fig. 8. A combination of MAAC and TSC aids in uniform perovskite film formation with large grain size, low-density defects, and an ultra-smooth surface and enhances the PCE as well as stability of PSCs. The highest PCE (19.19%) for inverted planar PSCs has been achieved by widely-used MAPbI$_3$. Interestingly, the PSCs retain over 80% of the initial efficiency after 42 days of continuous illumination or 20 days of thermal aging at 80 °C [81].

2.1.2. Two-step deposition

2.1.2.1. SDM. In 2013, Burschka et al. first introduced the SDM to fabricate a perovskite layer that considerably changed the PCE and resulted in a PCE of more than 15%. In this process, they succeed to fabricate highly efficient perovskite layer by the SDM [19,50,82]. One of the key advantages of the SDM is the uniform and smooth surface of the perovskite layer. A schematic of the SDM is shown in Fig. 9. In this method, a PbI$_2$ layer is spin-coated over the top of the substrate and then dried before being dipped into the MAI-isopropyl alcohol solution for full conversion to MAPbI$_3$.

Dipping the TiO$_2$/PbI$_2$ composite film into a CH$_3$NH$_3$I solution in 2-propanol changes the substrate’s colour instantly from yellow to dark...
brown, which indicates the formation of \( \text{CH}_3\text{NH}_3\text{PbI}_3 \) \[19\]. This method allows for the \( \text{PbI}_2 \) crystallites to be confined to a small size, which subsequently increases their rate of conversion to \( \text{CH}_3\text{NH}_3\text{PbI}_3 \). In the dipping process, the physical and optoelectronic properties of the MAPbI\(_3\) depend on the reaction time and solution concentration. A similar experiment was conducted for mp-TiO\(_2\) substrates; however, better efficiency was obtained by slight modification of this method by pre-wetting the PbI\(_2\) film by dipping it in iso-propanol for 1 s before dipped into the MAI solution. The SDM process exhibited 14.1% certified PCE. Using this approach, the morphology could be easily controlled with reduced defects and surface roughness of the perovskite film by controlling the concentration of the MAX solution. The SDM decreases the surface roughness and improves the pore filling of the perovskite absorber layer \[68\]. A few researchers \[83,84\] have reported that the formation of pinholes cannot be prevented in solution-processed film due to its natural mechanism \[85\] and a special separate treatment is needed to reduce pinhole formation. The imbalance of grain sizes and surface smoothness is one of the shortcomings of SDM, because surface smoothness decreases with the increase in grain size. Another drawback is the incomplete conversion of the perovskite compound. When PbI\(_2\) film is dipped into the MAI solution, lead halide readily reacts with the small surface molecules and forms a dense layer that impedes the penetration of MAI into the underlying layer; however, this issue is addressed by advanced device engineering \[5\].

In SDM, concentrations of MAI and PbI\(_2\) have a great impact on the morphology and electronic properties of the final perovskite film. A high concentration of MAI solution results in augmented iodine ions and reduced hole density in the \( \text{CH}_3\text{NH}_3\text{PbI}_3 \) layer. As a result, carrier density and charge transportability decrease, with low device efficiency \[86\]. Higher concentration of MAI contributes to more nuclei and smaller grains compared with lower concentrations of MAI \[87\]. The presence of impurities in the MAI solution and the polarity of the solvent also affect the morphology of the perovskite layer \[86\]. Post-treatments likewise thermal, solvent, and annealing treatments, also indicate significant effects on the morphology of the fabricated perovskite layer \[88,89\]. Fig. 10 explained the SEM images of perovskite film as a function of MAI different molarity. The SEM micrograph in Fig. 10(a) shows that the growth of the nucleation of perovskite crystal highly depends on the MAI concentration. The average grain size of the perovskites decreases with the increase in MAI concentration. A low concentration of MAI induces a low nucleation density, thereby increasing the average grain size. The surface coverage increases with the MAI concentration. In the case of 5 mg/ml MAI, untreated PbI\(_2\) forms densely packed crystals with nanoscale dimensions (Fig. 10(b)). However, when dipped into MAI, perovskite grains form, and their number and size increase as the reaction proceeds. The grains stop growing after 1.5 min of reaction. In the top view, it is clear that there is no residual PbI\(_2\) appear in perovskites film. The perovskite grains are sufficiently dense to prevent the penetration of MAI molecules. Thus, the chemical reaction remarkably slows down after the saturation time. In Fig. 10(c),

Fig. 7. SEM micrograph of perovskite film with (a) no PEG (pristine) (b) 1 wt% PEG (c) 2 wt% PEG, and (c) 3 wt% PEG as additives on the top of the TiO\(_2\) layer (Reprint permission from Ref. [74]).

Fig. 8. SEM micrograph (Top view) of perovskite films fabricated with (a) MAAc (b) MAAc + TSC in precursor (Reprint permission from Ref. [81]).
Fig. 9. Schematic illustration of fabrication method of perovskite layer by sequential deposition method.

Fig. 10. SEM micrograph of CH$_3$NH$_3$PbI$_3$ from reaction with (a) different concentrations (4, 5, 6, and 8 mg/ml) of MAI (b) reaction with MAI for 0 s, 10 s, 20 s, 45 s, 90 s, and 120 s with 5 mg/ml MAI in IPA. (c) Reaction with MAI for 0 s, 1 s, 10 s, 30 s, 60 s, and 180 s with 10 mg/ml MAI. All scale bars are 1 µm (Reprint permission from Ref. [90]).
when 10 mg per ml MAI is used, a lot of small CH$_3$NH$_3$PbI$_3$ grains initially form homogeneously. This morphology is sustained for a time; however, eventually, large single-crystal perovskite nanoplates, nanorods, and nanocubes begin to form, which indicate that single CH$_3$NH$_3$PbI$_3$ crystals may form by dissolution and recrystallization [90].

The PCE of PSCs can be stimulated by reducing the spinning rate and increasing the concentration of PbI$_2$ molecule. Fig. 11(a) and (d) indicate that uniform and pinhole-free perovskite layer on TiO$_2$ substrate cannot be obtained by spin coating the PbI$_2$ only once. The optical microscopic view reveals that the partial coverage on the TiO$_2$ film with perovskite crystals is mainly accredited to the relatively uneven surface of the PbI$_2$ films, as shown in Fig. 11(g), because the morphology of the perovskite absorber layer is mostly determined by the PbI$_2$ film [91]. The morphology of the PbI$_2$ film on TiO$_2$ is enhanced, and a whole coverage of perovskite on the TiO$_2$ film with interrelated crystals can be obtained, as shown in Fig. 11(h) by spin coating the PbI$_2$ solution for a second time. However, the effect of repeated spin coating of PbI$_2$ to improve the surface morphology remains vague, and obvious differences in the crystallisation have yet to be reported. Possible reasons that contribute to such a phenomenon could be the crystallisation-dissolution-recrystallisation route and an improvement in the surface moistening, which allows the highly concentrated PbI$_2$ solution to cover the mp-TiO$_2$ film homogenously.

2.1.2.2. Two-step spin-coating method. The two-step spin-coating method has been suggested to resolve the issue caused by the dipping method. In this method, the size of MAPbI$_3$ is observed and remarkably changed by the MAI conc. during the 2nd step of spin coating [87]. Fig. 12 depicts a schematic of the two-step spin-coating deposition technique. In this method, a PbI$_2$ layer is spin-coated over the top of the substrate and then dried. After cooling at room temperature, the CH$_3$NH$_3$I solution in 2-propanol is loaded again on top of the PbI$_2$-coated substrate by spin coating, and then dried again. This method was first proposed by Huang as a modified SDM method.

In case of single solvents, one-step spin coating is found to be poorer to two-step spin coating in terms PCE because of remarkable alterations in the morphology of MAPbI$_3$ [68]. The grain size of MAPbI$_3$ can be easily controlled by a two-step spin-coating method. For example, low concentrations produce large cuboid crystals, whereas high concentrations yield small cuboid MAPbI$_3$. In Fig. 13(a)-(e), the formation of MAPbI$_3$ cuboids is induced by the two-step spin coating procedure, and the size and shape of the cuboids are significantly biased by the MAI concentration [87]. Furthermore, the average cuboid size is approximately 720 nm for 0.038 M, and 90 nm for 0.063 M. The small cuboids are closely packed on the substrate, whereas the large cuboids have gaps between themselves and exhibit improved PCE because of enhanced internal light scattering, thereby leading to high photocurrent density ($J_{sc}$). However, the highest open-circuit voltage ($V_{oc}$) is not exhibited by the largest cuboids, but exhibits by the medium-sized cuboids. Delaying charge mobility may raise the chance of recombination, and is responsible for reducing the open circuit voltage of the largest cuboid. This result directs that the mobility for charge

![Fig. 11. Top view SEM micrograph of perovskite on mp-TiO$_2$ films. The PbI$_2$ was spin coated one (a, d), two (b, e) and three (c, f) times. Optical microscopic view of the PbI$_2$ films spin-coated (g) one time (h) two times, and (i) three times (Reprint permission from Ref. [92]).](image1)

![Fig. 12. Schematic diagram of obtaining perovskite layer by two-step spin-coating method.](image2)
extraction acts a vital role in controlling $V_{oc}$. The $J_{sc}$ increases with the size of MAPbI$_3$; thus, a higher $J_{sc}$ can be expected corresponding to the larger cuboid size. However, a higher $J_{sc}$ cannot be obtained from a few micron-sized MAPbI$_3$ cuboids, which are grown by further decreasing the MAI concentration. The size distribution widens with the decrease in CH$_3$NH$_3$I concentration, as shown in Fig. 13(f). The cuboid size of MAPbI$_3$ is plotted as a function of MAI conc. in Fig. 13(g), which illustrates an exponential decay in the cuboid size with MAI conc. An exponential function to an asymptotic plateau provides a good fit for the data, which suggests that the MAPbI$_3$ crystal growth strongly associated with MAI conc.

The dependence of the MAPbI$_3$ cuboid size on MAI conc. was studied by SEM at different loading times of 1, 5, 10, and 20 s for 0.038 M and 0.063 M MAI solution, as shown in Fig. 14. Crystal growth with waiting time is evident for the 0.038 M CH$_3$NH$_3$I solution, whereas no crystal growth occurs with waiting time for the higher conc. of 0.063 M. For 0.038 M, the growth in size is reduced possible by the low CH$_3$NH$_3$I concentration because the seed crystals are thinly distributed (Fig. 14(a)). This situation is also indicative of localised nucleation. In contrast to low-conc. case, further crystal growth is obstructed at the higher conc. because nucleation and growth are already completed at the initial stage (1 s), as shown in Fig. 14(b). The colour changed from light brown to dark black for the 0.038 M case; however, no change in colour was observed for the 0.063 M case [87].

2.2. Vapour-assisted processing

2.2.1. VASP

Snaith et al. proposed the VASP to avoid the pinhole formation issues within the perovskite films during perovskite layer deposition [85]. This process is a modification of the SDM, as shown in Fig. 15. This method is also known as two-step hybrid deposition. In this method, a PbI$_2$ layer is spin-coated over the top of the substrate, and MAI is then deposited through a vapour deposition technique rather than a solution-dipping process [5].

The VASP is based on the kinetic reactivity of MAI and the thermodynamic stability of perovskite during the growth process, and offers films with certain grain structure, large crystal sizes, entire surface coverage, and negligible surface roughness that are suitable for PV applications. Morphology and grain size can be controlled by this method via gas–solid crystallisation. However, this method is limited in gas–solid reactions [82]. The PCE of PSCs based on films prepared via the VASP method reaches up to 12.1%, which is thus far the highest PCE in PSC with a planar structure [87].

Fig. 16 shows the CH$_3$NH$_3$PbI$_3$ films deposited on the top of FTO-coated glass with a compact TiO$_2$ layer via VASP method. Fig. 16(a) shows corresponding XRD of the as-prepared perovskite film. Orthorhombic crystal structure of MAPbI$_3$ with high crystallinity is obtained due to the presence of strong peaks at 14.08°, 28.41°, 31.85°, and 43.19°.
The absence of any small signature peak at 12.65° endorses the absence of unchanged PbI₂ film, and suggests a complete consumption of PbI₂ via the VASP [90]. Fig. 16(b) shows the top-view SEM image of perovskite film covering the full surface of the substrate, with remarkable grain size up to the micro scale. The surface roughness measured by AFM is shown in Fig. 16(c) and is calculated to be 23.2 nm. The film roughness is smaller compared with other solution process techniques [19]. The cross-sectional SEM micrograph of MAPbI₃ film on the FTO/c-TiO₂ substrate reveals definite grain structure with a 350 nm thickness (Fig. 16(d)). Uniform grain structure, microscale grain size, and full surface coverage indicate the pertinence of use in PV devices [87]. Nevertheless, the SEM image of the VASP confirms almost zero pinholes compared with solution-processed thin films. Chen et al. reported on perovskite layers formed by the VASP and SDM on top of a TiO₂ scaffold, which shows the distinctive properties of the crystal size (Fig. 18(b)). The vapour-deposited perovskite film is flat and uniform, with slightly larger crystal features [17].

After deposition, the colour of the perovskite film varies depending on the composition of PbX₂ and MAX. Reddish-brown perovskite film is observed for the best performing PSCs, and films are shown partially crystallised in the topological SEM image of the as-deposited film (Fig. 18(c)). Annealing perovskite films in the N₂-filled glove box facilitates full crystallisation of the perovskite, darkens the colour, and results in the apparent growth of the crystal features visible in the SEM micrograph, as shown in Fig. 18(d) [17]. Afterwards the deposition of thermally evaporated perovskite, annealing significantly affects the outstanding crystal growth and film quality. Fig. 19(a) and (b) show the morphology of perovskite before and after annealing, respectively. Perovskite film studied after immediate deposition reveals a complex morphology, with a homogeneous and unstructured layer with a few arbitrarily dispersed greater aggregates. After annealing, the MAPbI₃ perovskite film changes to a highly diverse morphology with homogenously distributed perovskite polycrystals with sizes between 100 nm and 200 nm and well-defined terracing, thereby entirely covering the substrate [94]. The outcome recommends the formation of a crystalline MAPbI₃ film, which is alike to that earlier reported by Yu et al. on spin-coated perovskite films. XRD patterns in the insets of Fig. 19(a) and (b) disclose the cubic phase of perovskite and similar peak intensity enhancement after annealing, indicating that perovskite evolution is not hindered by the underlying film [95].

**2.2.2. TVD**

TVD for the perovskite absorber layer was first introduced by David B. Mitzi, and was reproduced by Liu et al. for planar heterojunction MAPbI₃−ₓClₓ PSCs with a PCE of 15.4% [17]. In this method, MAPbI₃ absorber was deposited by a dual-source evaporation system in a nitrogen-filled glove box. The compact layer was initially deposited atop FTO coated glass. Vapour-deposited perovskite films were then fabricated atop the compact layer. Extremely uniform and total surface area coverage are the main advantages of the TVD method, but controlling the vapour phase reaction is crucial. In this method, MAX and PbX₂ are simultaneously evaporated from different sources at definite molar ratios under high vacuum, as shown in Fig. 17. A film of dark reddish-brown was obtained after evaporation, and then annealed [17].

The top and cross-sectional views of the SEM micrograph of perovskite film deposited by vapour deposition are shown in Figs. 18(a) and 18(b). Fig. 18(a) illustrates that the vapour-deposited films are tremendously uniform, and cover the entire surface area of the TiO₂ compact layer with a length scale of hundreds of nanometres. The cross-sectional images of the completed PSC devices roughly reveal evidence of the crystal size (Fig. 18(b)). The vapour-deposited perovskite film is flat and uniform, with slightly larger crystal features [17].

CVD has been considered a mature industrial technology for the fabrication of perovskite film, and has been widely used in commercial deposition [96,97]. Generally, CVD covers tubular CVD, metal–organic CVD, plasma-enhanced CVD and photo-initiated CVD. [96,98–102]. The tubular CVD method has been successfully applied for the deposition of PSCs and has revealed outstanding results [103,104]. The process parameters of tubular CVD, such as reaction temperature, growth ambient environment, and vapour pressure can be effectively controlled
in a small quartz chamber. Notably, the slow gas-phase reaction nature can reduce the over-rapid inserting reaction rate in perovskites, which accordingly produces smooth and uniform perovskite films [103]. Hybrid CVD (HCVD) and low-pressure CVD (LPCVD) are widely used CVD methods for perovskite deposition. However, rest of the CVD methods are not used in practice because they require complex fabrication tools.

2.2.3.1. HCVD. In 2014, Qi et al. first introduced HCVD technology for the effective deposition of a perovskite layer [104]. Vacuum thermal evaporation and gas-phase deposition were chronologically used to fabricate perovskite films. In this method, PbX$_2$ was initially evaporated in a high-vacuum environment to obtain uniform films, and MAI was then heated to 185 °C and transported into the reaction site by N$_2$ gas. Finally, a post-annealing process was conducted on the as-prepared films in air or glove box. A schematic of the HCVD method is shown in Fig. 20. In this method, growth temperature is the key factor for fabricating high-quality perovskite films. A higher temperature did not ensure perovskite film formation, whereas films formed at a lower temperature were unstable in air.

On the basis of the relation between the gas diffusion constant, growth temperature, and gas pressure, the gas diffusion rate should be effectively tuned by an optimal combination of temperature and pressure [105]. Given that the growth temperature is limited to approximately 170 °C, the diffusion rate in HCVD can be varied over a wide range by controlling its gas pressure. Thus, high-quality perovskite films with smooth, fully covered surfaces are achieved by using the HCVD method [106]. Leyden et al. showed the influence of the thickness of the pre-deposited lead halide layer and successive MAPbI$_3$ on the average PCE of PSCs. Fig. 21(a) and (b) indicate that a peak with the best efficiency is evident at a lead halide layer thickness of ≈ 100 nm, which corresponds to ≈ 300 nm thick MAPbI$_3$ films [104]. The surface morphology after air annealing was different from surfaces annealed in a N$_2$ environment. Perovskite films annealed in air resulted in higher PSC performance compared with films obtained from N$_2$ annealing, providing a maximum efficiency of 11.8% and an average PCE of 10.8%; whereas N$_2$-annealed perovskite films resulted in an average efficiency of 6.1% and a maximum of 8.8%. In addition, these cells retained nearly the same PV performance after around 46 days of storage in dry N$_2$ gas, thereby exhibiting excellent stability.

Fig. 21(c) shows a photograph of a completed and functioning device by the HCVD method forecast, where the film is partially transparent and homogeneous. Fig. 21(d) presents the absorbance spectrum of a completed device, where the absorption edge is measured at 781 nm [42], thereby making the approach suitable for applications that include PV windows and multi-junction solar cells [107].

2.2.3.2. Ambient atmosphere vapour-assisted deposition. In 2016, Zheng et al. reported another significant two-step HCVD method, and achieved the highest efficiency among vapour-based routes. High-quality perovskite films in open air have been fabricated by this method, which was considered a significant progress in the CVD fabrication of PSCs. In this method, the heating source was altered using hot airflow through the outer tube in lieu of normally used...
electrothermal method. The airflow was produced from a heat gun that controlled the flow rate and temperature. MAI vapour was transported onto the PbI2 substrate via a carrier gas, which was also injected as hot air through the provided hole at the head of the inner glass tube. The humidity of the reaction chamber was strictly controlled, and the relative humidity (RH) was maintained at one-fourth of the ambient RH value. A schematic of the ambient atmosphere vapour-assisted deposition technique is shown in Fig. 22.

Photographs of perovskite film fabricated by the ambient atmosphere vapour-assisted deposition method on an FTO/cTiO2 substrate, top-view and cross-sectional micrographs of as-grown perovskite film are shown in Fig. 23(a)–(c). A uniform perovskite film thickness with dense surface morphology and large crystal domains can be observed from the surface and cross-sectional SEM images. The fabrication method is completely performed in an ambient atmosphere, and exhibits high environmental tolerance. This approach is an effective technology for fabricating PSCs for commercialisation [108].

2.2.3.3. LPCVD. The LPCVD method was first introduced in the fabrication of PSCs by Luo et al. in 2015 [103]. LPCVD technology can meritoriously minimise the over-rapid intercalating reaction rate and easily overcome this blocking issue during the solution process. Perovskite films obtained by the LPCVD method displays good crystallisation, strong absorption, long carrier diffusion length, and exceptional humid resistant features even under laser illumination and high-temperature conditions [97,100]. A schematic of the LPCVD method is shown in Fig. 24.

In the LPCVD deposition technique, PbI2 precursor films are first prepared by spin coating. After vacuum pumping for pressure reduction, MAI powder and PbI2 film are placed in heating zones A and B, respectively, and are heated separately at different temperatures. The MAI vapour reacts with the PbI2 precursor film via a gas–solid reaction process. Low cost, low energy consumption and high reaction yield are the main advantages of the LPCVD method. MAPbI3 films with good crystallisation, long carrier diffusion length, strong absorption, and high stability have been achieved by the LPCVD technique [106]. Morphology and the composition of the perovskite absorber are the main indicators for attaining highly efficient PSCs. Thus, smooth, nonporous and compact MAPbI3 films must be attained to prevent the shunt current that generally arises from direct contact with the corresponding charge carrier layers. The solution-based process consistently
Fig. 21. a) PCE as a function of film thickness, \(N_2\) (black dots) and air annealed (red dots) b) I-V Curve (c) HCVD SCs with front illumination from a fluorescent light bulb (d) UV-vis spectrum of a complete cell (Reprint permission from Ref. [104]).

Fig. 22. Schematic diagram of the ambient atmosphere vapour-assisted deposition method.

Fig. 23. (a) Photographs of the as-deposited MAPbI\(_3\) film on FTO/c-TiO\(_2\) substrate. SEM micrographs of (b) the top-view, and (c) cross-sectional image of the as-deposited MAPbI\(_3\) film (Reprint permission from Ref. [108]).

Fig. 24. Schematic diagram of LPCVD instrument.
produces bare pinholes and large grains [19,70]; nevertheless, the LPCVD technique exhibits better morphology, which has been verified by AFM, SEM, and metallurgical microscopy, as shown in Fig. 25.

The SEM investigation in Fig. 25(a)–(d) reveals that a homogeneous, uniform, and well-defined perovskite layer can be obtained by the LPCVD technique. The metallurgical micrograph in Fig. 25(e) indicates that films deposited by the LPCVD method are extremely dense and compact, and have super uniformity, which indicate a high level of crystallisation. The 2-D AFM height image in Fig. 25(f) shows that the calculated roughness of the homogenous films is only 19.6 nm. The bearing depth over a 2 × 2 µm 3-D AFM graph is also only 78 nm.

![Fig. 25. Low and high magnification top surface (a-b) and cross-sectional (c-d) SEM micrographs of CH$_3$NH$_3$PbI$_3$ absorbers. (e) Metallurgical micrograph, and (f) 2-D AFM height image of CH$_3$NH$_3$PbI$_3$ absorbers (Reprint permission from Ref. [103]).](image-url)

![Fig. 26. Schematic diagram of in situ chemical vapour deposition (ITCVD) equipment.](image-url)

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![Fig. 27. a) SEM of perovskite films, and b) photographs of large demonstrated sample via ITCVD (Reprint permission from Ref. [109]).](image-url)
2.2.3.4. In situ tubular chemical vapour deposition (ITCVD). Solution-based technology and the thermal evaporation route remain challenging for producing low-cost, large-scale, and highly uniform perovskite absorber layers. Luo et al. proposed the ITCVD technique to overcome the aforementioned limitations [109]. The main advantages of ITCVD are its cost-effectiveness and minimal equipment requirements, such as glove box or vacuum instruments [17,110]. The approach can potentially be applied to large surface area deposition. In comparison with HCVD and LPCVD, only time and temperature must be controlled, which indicates that ITCVD is easier to control than other thermal techniques. A schematic of ITCVD equipment is shown in Fig. 26.

In the ITCVD technique, a PbI$_2$ solution is initially spin-coated on top of the compact TiO$_2$ film. The lead halide-coated FTO/ITO substrate is then directly positioned at the top of the MAI vapour, and heated at a specific temperature for a specified period. Thereafter, the reacted film is removed and washed with 2-propanol, and annealed at 145 °C for 30 min in ambient environment. The SEM micrograph in Fig. 27(a) indicates that the ITCVD technique produces dense and precise perovskite film with grain sizes at the submicron level. An interesting feature of the ITCVD technique is that it provides large-size samples, which indicate its ability to scale in future mass production (Fig. 27(b)).

2.2.3.5. Aerosol-assisted chemical vapour deposition (AACVD). To obtain thick and uniform perovskite thin film, a modified three-step AACVD method was proposed by Afzal et al. [111]. However, the AACVD method was originally introduced by Chen in 2016 [112]. A solution-based AACVD method using aerosol droplets to transport precursors provides an alternative for depositing perovskite films at ambient pressure. Several research groups have validated a one-step AACVD method to deposit perovskite thin films [113,114], but the deposited films were likely to be of low density and composed of powdery agglomerates due to early gas-phase nucleation between lead halide and MAI at the deposition temperatures. Compared with other deposition methods, AACVD is a low-cost and scalable technique. Although dense and uniform perovskite film can be grown by the AACVD method, the growth process is very challenging. A schematic of the AACVD method is shown in Fig. 28.

In the AACVD deposition technique, a cold-walled horizontal-bed AACVD reactor was used to deposit perovskite film. The system was continuously purged with N$_2$ before conducting the experiment to reduce moisture and contaminants. In the first step, PbI$_2$ films are prepared by using an aerosol of PbI$_2$ in DMF for 1 h. In the second step, DMF is evaporated at 70 °C for 5 min. After evaporating the DMF, an MAI solution is introduced into the system via aerosol at 220 °C (third stage) for 1 h. The N$_2$ gas is passed through the reactor during the course of the experiment. After deposition, the films are immediately removed from the reactor and transferred to an N$_2$ glove box. Afzal et al. showed the formation of stable tetragonal high-quality perovskite structures with minor impurity and strong absorption and emission characteristics at room temperature using the three-step AACVD method. The SEM micrographs are shown in Fig. 29(a) display a dense and pinhole-free perovskite film grown by the AACVD method. The
treat the perovskite film for several minutes at a fixed output power. MIP is a one-step process in which microwave irradiation is used to heat methods that have been widely applied in OPVs [116,117]. The perovskite films [115]. The MIP is a non-contact, rapid, and selective heating method reported by Ahn et al. in which PbI₂, CH₃NH₃I, and DMSO with a molar ratio of 1:1:1 are mixed in dry DMF solution at room temperature and stirred for 60 min. Then, the MAPbI₃ precursor is spin-coated on the mp-TiO₂, and 0.5 ml of (C₂H₅)₂O is dripped on the spinning substrate, which is then annealed at different temperature. At first, the samples are positioned on a Teflon shelf and then in a microwave oven (160 W) for several minutes [118]. A schematic of the MIP is shown in Fig. 30. In the MIP, the solvent is evaporated directly and the perovskite film forms quickly. In a compare with other annealing processes, the MIP assists fast and controllable crystallisation of MAPbI₃ films with minimal energy input and time consumption [115].

The effect of microwave irradiation duration on the morphology of MAPbI₃ film is illustrated in Fig. 31(a)–(f); the figures indicate that perovskite is uniformly distributed over the substrate. Fig. 31(g) shows that the trend of the corresponding grain size of the MAPbI₃ films linearly increases with the duration of microwave irradiation treatment. Thus, the grain size of the MAPbI₃ film can be regulated by altering the time allowed for microwave irradiation treatment. Given that the growth rate of MAPbI₃ grains is sensitive to the annealing rate and temperature, the crystallisation of MAPbI₃ film can be controlled by accurately varying the power and time of microwave irradiation. At long irradiation periods, some grain boundaries shrink and show cracks between the grains, as shown in Fig. 31(d) and (e) [115].

3. Future outlook

Among the existing renewable energy technologies available today, PV technologies are the most promising and fastest-growing technologies that may offer a solution to the upcoming energy crisis. Of all PV technologies, lead halide PSCs have drawn considerable attention and interest due to their rapid growth in power conversion efficiency. However, the most challenging aspect of PSCs is to grow a hydrophobic perovskite layer that can produce a stable and high-performance perovskite device. This can be achieved through the surface modification of the perovskite layer via additives, ionic liquids, and hydrophobic moiety. Toxic lead is another critical drawback for PSCs. New inorganic materials must be found to replace toxic lead. To minimise the cost of PSCs, researchers should focus on depositing the perovskite under ambient conditions. Narrow bandgap perovskite materials and plasmonic PVS are expected to usher in a new era of light harvesting technology. Future research should include studies on the effects of defect type, defect density, and associated PV effect mechanisms. Development of stable and efficient lead halide PSCs demands advance studies to develop new materials and device structures to mitigate the future power crisis.

4. Conclusion

In this review, we provide an outline of the deposition techniques that control the structure and morphology of the perovskite layer and ultimately regulate the PCE and stability of PSCs. The film quality of perovskite plays a significant role in determining the overall performance of solar cells, such that perovskite films with high phase purity, low structural defects, suitable morphology, high crystallinity, and appropriate deposition technique with respect to the processing condition and composition of the perovskite precursor are required. Annealing temperature, film thickness, and substrate materials are the key parameters that affect the film quality in the OSD method. Pinhole formation and slow crystallisation are challenges in the OSD method; however, the dripping of anti-solvent controls the kinetics of crystal growth with a large grain size. SDM decreases the surface roughness and reduces the pinholes of the perovskite absorber layer. The disparity of grain size and surface smoothness is one shortcoming of the SDM, because surface smoothness decreases with the increase in grain size. Another drawback is the incomplete conversion of perovskite. The crystal size of MAPbI₃ can be easily controlled by a two-step spin-coating method. A low concentration of MAI produces a large cubic crystal, whereas a high concentration yields small cubic MAPbI₃. The VASP is based on the kinetic reactivity of MAI and thermal stability of MAPbI₃ during the growth process, and offers films with certain grain structure along with grain sizes, entire surface coverage, and minor surface roughness that are suitable for PV applications. Morphology and
grain size can be controlled by this method via gas–solid crystallisation. However, this method is limited in gas-solid reactions. Extremely uniform surface coverage, a lack of pinholes, and large grain size are advantages of TVD; however, TVD requires a long time for deposition, and controlling the temperature is difficult. CVD is considered a mature industrial technology and is widely used in commercial deposition. Reaction temperature, growth ambient condition, and vapour pressure can be effectively controlled using the CVD method. The MIP is a non-contact, rapid, and selective heating method. In comparison with other techniques for controllable crystallisation of perovskite films with minimal energy loss and time consumption. Many studies are ongoing among PV research communities for the commercialisation of PSCs. Unprecedented growth efficiency within a short time is expected, although objections remain concerning stability, use of toxic lead, and flexible substrate issues. Given that the MIP presents excellent optical and electrical properties, high PCE, and cheap and facile film quality, we anticipate that new solar technology based on perovskite is promised for the future PV market.

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